Group Art Unit: 2891

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

)

	Pei-Haw Tsao <i>et al</i> .	) )	Examiner:	Dana Farahani
Serial No.:	10/711,503	) )		
Filed·	September 22, 2004	) }		

For: IC PACKAGE HAVING GROUND IC CHIP AND METHOD OF MANUFACTURING SAME

MANUFACTURING SAME

## Submitted via EFS

In re Application of:

Mail Stop: **AF**Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

Dear Sir:

## **AMENDMENT UNDER 37 C.F.R. 1.116**

This communication is in response to the Final Office Action of June 29, 2006.

The Applicants note that the three month deadline for filing a response to this Final Office Action is September 29, 2006; thus, this Amendment is timely and is being filed with a Request for Continued Examination.